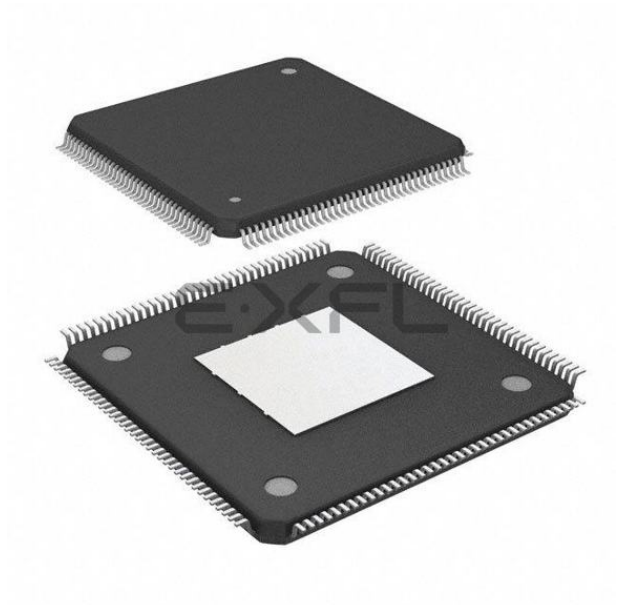

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	645
Number of Logic Elements/Cells	10320
Total RAM Bits	423936
Number of I/O	91
Number of Gates	-
Voltage - Supply	1.15V ~ 1.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP Exposed Pad
Supplier Device Package	144-EQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep4ce10e22c7n

Visual Cue	Meaning
Courier type	Indicates signal, port, register, bit, block, and primitive names. For example, `data1`, `tdi`, and `input`. The suffix `n` denotes an active-low signal. For example, `resetn`. Indicates command line commands and anything that must be typed exactly as it appears. For example, `c:\qdesigns\tutorial\chiptrip.gdf`. Also indicates sections of an actual file, such as a Report File, references to parts of files (for example, the AHDL keyword `SUBDESIGN`), and logic function names (for example, `TRI`).
↵	An angled arrow instructs you to press the Enter key.
1., 2., 3., and a., b., c., and so on	Numbered steps indicate a list of items when the sequence of the items is important, such as the steps listed in a procedure.
■ ■ ■	Bullets indicate a list of items when the sequence of the items is not important.
	The hand points to information that requires special attention.
	The question mark directs you to a software help system with related information.
	The feet direct you to another document or website with related information.
	The multimedia icon directs you to a related multimedia presentation.
	A caution calls attention to a condition or possible situation that can damage or destroy the product or your work.
	A warning calls attention to a condition or possible situation that can cause you injury.
	The envelope links to the Email Subscription Management Center page of the Altera website, where you can sign up to receive update notifications for Altera documents.

When designing LVTTL/LVCMOS inputs with Cyclone IV devices, refer to the following guidelines:

- All pins accept input voltage (V_I) up to a maximum limit (3.6 V), as stated in the recommended operating conditions provided in the *Cyclone IV Device Datasheet* chapter.
- Whenever the input level is higher than the bank V_{CCIO}, expect higher leakage current.
- The LVTTL/LVCMOS I/O standard input pins can only meet the V_{IH} and V_{IL} levels according to bank voltage level.

Voltage-referenced standards are supported in an I/O bank using any number of single-ended or differential standards, as long as they use the same V_{REF} and V_{CCIO} values. For example, if you choose to implement both SSTL-2 and SSTL-18 in your Cyclone IV devices, I/O pins using these standards—because they require different V_{REF} values—must be in different banks from each other. However, the same I/O bank can support SSTL-2 and 2.5-V LVCMOS with the V_{CCIO} set to 2.5 V and the V_{REF} set to 1.25 V.

☞ When using Cyclone IV devices as a receiver in 3.3-, 3.0-, or 2.5-V LVTTL/LVCMOS systems, you are responsible for managing overshoot or undershoot to stay in the absolute maximum ratings and the recommended operating conditions, provided in the *Cyclone IV Device Datasheet* chapter.

☞ The PCI clamping diode is enabled by default in the Quartus II software for input signals with bank V_{CCIO} at 2.5, 3.0, or 3.3 V.

High-Speed Differential Interfaces

Cyclone IV devices can send and receive data through LVDS signals. For the LVDS transmitter and receiver, the input and output pins of Cyclone IV devices support serialization and deserialization through internal logic.

The BLVDS extends the benefits of LVDS to multipoint applications such as bidirectional backplanes. The loading effect and the need to terminate the bus at both ends for multipoint applications require BLVDS to drive out a higher current than LVDS to produce a comparable voltage swing. All the I/O banks of Cyclone IV devices support BLVDS for user I/O pins.

The RSDS and mini-LVDS standards are derivatives of the LVDS standard. The RSDS and mini-LVDS I/O standards are similar in electrical characteristics to LVDS, but have a smaller voltage swing and therefore provide increased power benefits and reduced electromagnetic interference (EMI).

The PPDS standard is the next generation of the RSDS standard introduced by National Semiconductor Corporation. Cyclone IV devices meet the National Semiconductor Corporation PPDS Interface Specification and support the PPDS standard for outputs only. All the I/O banks of Cyclone IV devices support the PPDS standard for output pins only.

The LVDS standard does not require an input reference voltage, but it does require a 100-Ω termination resistor between the two signals at the input buffer. An external resistor network is required on the transmitter side for the top and bottom I/O banks.

Table 6–6 and Table 6–7 summarize which I/O banks support these I/O standards in the Cyclone IV device family.

Table 6–6. Differential I/O Standards Supported in Cyclone IV E I/O Banks

Differential I/O Standards	I/O Bank Location	External Resistor Network at Transmitter	Transmitter (TX)	Receiver (RX)
LVDS	1,2,5,6	Not Required	✓	✓
	All	Three Resistors		
RSDS	1,2,5,6	Not Required	✓	—
	3,4,7,8	Three Resistors		
	All	Single Resistor		
mini-LVDS	1,2,5,6	Not Required	✓	—
	All	Three Resistors		
PPDS	1,2,5,6	Not Required	✓	—
	All	Three Resistors		
BLVDS *(1)*	All	Single Resistor	✓	✓
LVPECL *(2)*	All	—	—	✓
Differential SSTL-2 *(3)*	All	—	✓	✓
Differential SSTL-18 *(3)*	All	—	✓	✓
Differential HSTL-18 *(3)*	All	—	✓	✓
Differential HSTL-15 *(3)*	All	—	✓	✓
Differential HSTL-12 *(3)*, *(4)*	All	—	✓	✓

Notes to Table 6–6:

(1) Transmitter and Receiver f_{MAX} depend on system topology and performance requirement.

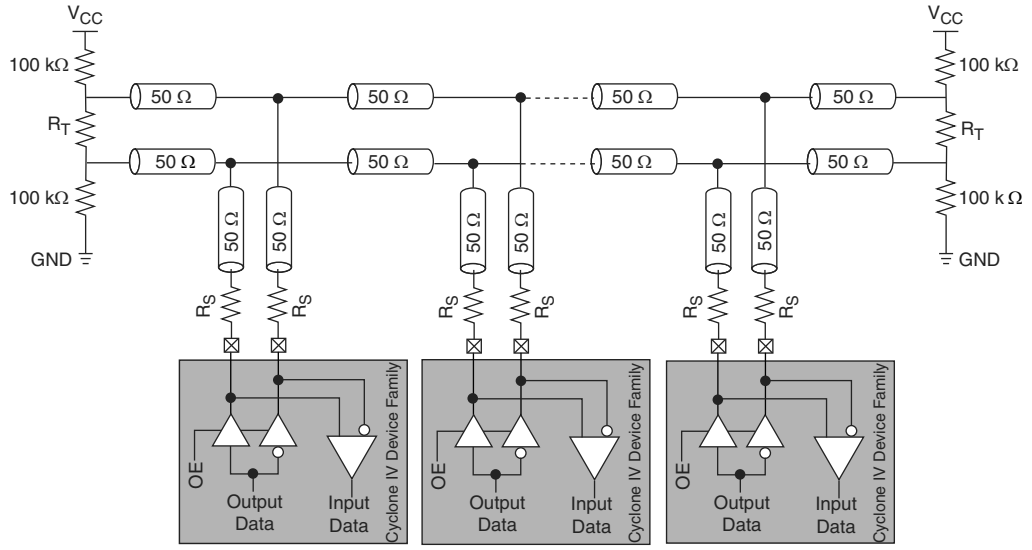
(2) The LVPECL I/O standard is only supported on dedicated clock input pins.

(3) The differential SSTL-2, SSTL-18, HSTL-18, HSTL-15, and HSTL-12 I/O standards are only supported on clock input pins and PLL output clock pins. PLL output clock pins do not support Class II interface type of differential SSTL-18, HSTL-18, HSTL-15, and HSTL-12 I/O standards.

(4) Differential HSTL-12 Class II is supported only in column I/O banks.

Figure 6–14 shows a typical BLVDS topology with multiple transmitter and receiver pairs.

Figure 6–14. BLVDS Topology with Cyclone IV Devices Transmitters and Receivers



The BLVDS I/O standard is supported on the top, bottom, and right I/O banks of Cyclone IV devices. The BLVDS transmitter uses two single-ended output buffers with the second output buffer programmed as inverted, while the BLVDS receiver uses a true LVDS input buffer. The transmitter and receiver share the same pins. An output-enabled (OE) signal is required to tristate the output buffers when the LVDS input buffer receives a signal.

For more information, refer to the *Cyclone IV Device Datasheet* chapter.

Designing with BLVDS

The BLVDS bidirectional communication requires termination at both ends of the bus in BLVDS. The termination resistor (R_T) must match the bus differential impedance, which in turn depends on the loading on the bus. Increasing the load decreases the bus differential impedance. With termination at both ends of the bus, termination is not required between the two signals at the input buffer. A single series resistor (R_S) is required at the output buffer to match the output buffer impedance to the transmission line impedance. However, this series resistor affects the voltage swing at the input buffer. The maximum data rate achievable depends on many factors.

Altera recommends that you perform simulation using the IBIS model while considering factors such as bus loading, termination values, and output and input buffer location on the bus to ensure that the required performance is achieved.

For more information about BLVDS interface support in Altera devices, refer to *AN 522: Implementing Bus LVDS Interface in Supported Altera Device Families*.

devices. The internal oscillator is designed to ensure that its maximum frequency is guaranteed to meet EPCS device specifications. Cyclone IV devices offer the option to select CLKUSR as the external clock source for DCLK. You can change the clock source option in the Quartus II software in the **Configuration** tab of the **Device and Pin Options** dialog box.

EPCS1 does not support Cyclone IV devices because of its insufficient memory capacity.

Table 8–6. AS DCLK Output Frequency

Oscillator	Minimum	Typical	Maximum	Unit
40 MHz	20	30	40	MHz

In configuration mode, the Cyclone IV device enables the serial configuration device by driving the nCSO output pin low, which connects to the nCS pin of the configuration device. The Cyclone IV device uses the DCLK and DATA[1] pins to send operation commands and read address signals to the serial configuration device. The configuration device provides data on its DATA pin, which connects to the DATA[0] input of the Cyclone IV device.

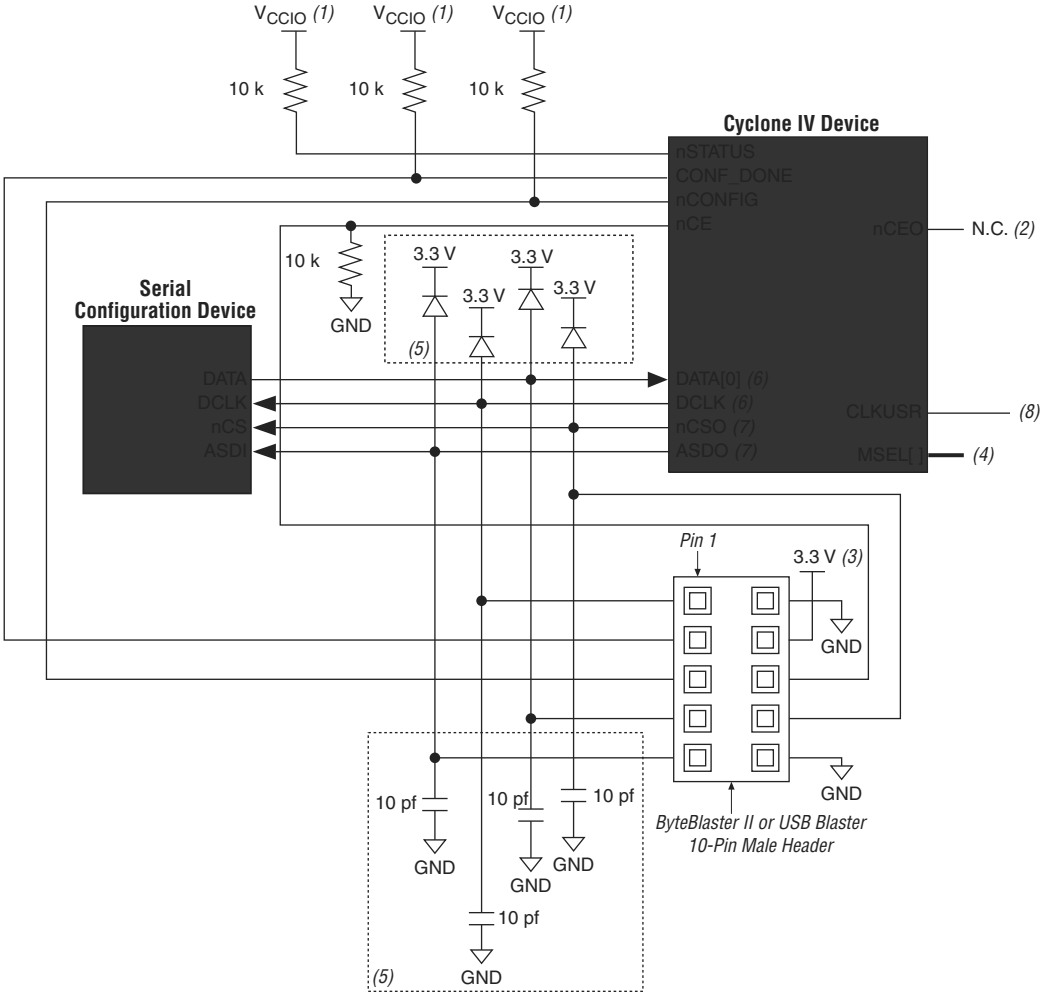
All AS configuration pins (DATA[0], DCLK, nCSO, and DATA[1]) have weak internal pull-up resistors that are always active. After configuration, these pins are set as input tri-stated and are driven high by the weak internal pull-up resistors.

The timing parameters for AS mode are not listed here because the t_{CF2CD}, t_{CF2ST0}, t_{CFG}, t_{STATUS}, t_{CF2ST1}, and t_{CD2UM} timing parameters are identical to the timing parameters for PS mode shown in Table 8–12 on page 8–36.

For more information about the USB-Blaster download cable, refer to the *USB-Blaster Download Cable User Guide*. For more information about the ByteBlaster II download cable, refer to the *ByteBlaster II Download Cable User Guide*.

Figure 8–6 shows the download cable connections to the serial configuration device.

Figure 8–6. In-System Programming of Serial Configuration Devices



Notes to Figure 8–6:

(1) Connect these pull-up resistors to the V_{CCIO} supply of the bank in which the pin resides.

(2) The nCEO pin is left unconnected or used as a user I/O pin when it does not feed the nCE pin of another device.

(3) Power up the V_{CC} of the ByteBlaster II or USB-Blaster download cable with the 3.3-V supply.

(4) The MSEL pin settings vary for different configuration voltage standards and POR time. To connect the MSEL pins, refer to Table 8–3 on page 8–8, Table 8–4 on page 8–8, and Table 8–5 on page 8–9. Connect the MSEL pins directly to V_{CCA} or GND.

(5) The diodes and capacitors must be placed as close as possible to the Cyclone IV device. You must ensure that the diodes and capacitors maintain a maximum AC voltage of 4.1 V. The external diodes and capacitors are required to prevent damage to the Cyclone IV device AS configuration input pins due to possible overshoot when programming the serial configuration device with a download cable. Altera recommends using the Schottky diode, which has a relatively lower forward diode voltage (VF) than the switching and Zener diodes, for effective voltage clamping.

(6) When cascading Cyclone IV devices in a multi-device AS configuration, connect the repeater buffers between the master and slave devices for DATA[0] and DCLK. All I/O inputs must maintain a maximum AC voltage of 4.1 V. The output resistance of the repeater buffers must fit the maximum overshoot equation outlined in "Configuration and JTAG Pin I/O Requirements" on page 8–5.

(7) These pins are dual-purpose I/O pins. The nCSO pin functions as FLASH_nCE pin in AP mode. The ASDO pin functions as DATA[1] pin in AP and FPP modes.

(8) Only Cyclone IV GX devices have an option to select CLKUSR (40 MHz maximum) as the external clock source for DCLK.

In user mode, Cyclone IV devices support the CHANGE_EDREG JTAG instruction, that allows you to write to the 32-bit storage register. You can use Jam™ STAPL files (**.jam**) to automate the testing and verification process. You can only execute this instruction when the device is in user mode, and it is a powerful design feature that enables you to dynamically verify the CRC functionality in-system without having to reconfigure the device. You can then use the CRC circuit to check for real errors induced by an SEU.

Table 9–1 describes the CHANGE_EDREG JTAG instructions.

Table 9–1. CHANGE_EDREG JTAG Instruction

JTAG Instruction	Instruction Code	Description
CHANGE_EDREG	00 0001 0101	This instruction connects the 32-bit CRC storage register between TDI and TDO. Any precomputed CRC is loaded into the CRC storage register to test the operation of the error detection CRC circuitry at the CRC_ERROR pin.

After the test completes, Altera recommends that you power cycle the device.

Automated SEU Detection

Cyclone IV devices offer on-chip circuitry for automated checking of SEU detection. Applications that require the device to operate error-free at high elevations or in close proximity to earth's north or south pole require periodic checks to ensure continued data integrity. The error detection cyclic redundancy code feature controlled by the **Device and Pin Options** dialog box in the Quartus II software uses a 32-bit CRC circuit to ensure data reliability and is one of the best options for mitigating SEU.

You can implement the error detection CRC feature with existing circuitry in Cyclone IV devices, eliminating the need for external logic. The CRC is computed by the device during configuration and checked against an automatically computed CRC during normal operation. The CRC_ERROR pin reports a soft error when configuration CRAM data is corrupted. You must decide whether to reconfigure the FPGA by strobing the nCONFIG pin low or ignore the error.

CRC_ERROR Pin

A specific CRC_ERROR error detection pin is required to monitor the results of the error detection circuitry during user mode. Table 9–2 describes the CRC_ERROR pin.

Table 9–2. Cyclone IV Device CRC_ERROR Pin Description

CRC_ERROR Pin Type	Description
I/O, Output (open-drain)	Active high signal indicates that the error detection circuit has detected errors in the configuration SRAM bits. This pin is optional and is used when the CRC error detection circuit is enabled in the Quartus II software from the **Error Detection CRC** tab of the **Device and Pin Options** dialog box. When using this pin, connect it to an external 10-kΩ pull-up resistor to an acceptable voltage that satisfies the input voltage of the receiving device.

The CRC_ERROR pin information for Cyclone IV devices is reported in the Cyclone IV Devices Pin-Outs on the Altera® website.

Table 9–6 lists the estimated time for each CRC calculation with minimum and maximum clock frequencies for Cyclone IV devices.

Table 9–6. CRC Calculation Time

Device		Minimum Time (ms) (1)	Maximum Time (s) (2)
Cyclone IV E	EP4CE6 (3)	5	2.29
	EP4CE10 (3)	5	2.29
	EP4CE15 (3)	7	3.17
	EP4CE22 (3)	9	4.51
	EP4CE30 (3)	15	7.48
	EP4CE40 (3)	15	7.48
	EP4CE55 (3)	23	11.77
	EP4CE75 (3)	31	15.81
	EP4CE115 (3)	45	22.67
Cyclone IV GX	EP4CGX15	6	2.93
	EP4CGX22	12	5.95
	EP4CGX30	12	5.95
		34 (4)	17.34 (4)
	EP4CGX50	34	17.34
	EP4CGX75	34	17.34
	EP4CGX110	62	31.27
	EP4CGX150	62	31.27

Notes to Table 9–6:

(1) The minimum time corresponds to the maximum error detection clock frequency and may vary with different processes, voltages, and temperatures (PVT).

(2) The maximum time corresponds to the minimum error detection clock frequency and may vary with different PVT.

(3) Only applicable for device with 1.2-V core voltage

(4) Only applicable for the F484 device package.

Software Support

Enabling the CRC error detection feature in the Quartus II software generates the CRC_ERROR output to the optional dual purpose CRC_ERROR pin.

To enable the error detection feature using CRC, perform the following steps:

1. Open the Quartus II software and load a project using Cyclone IV devices.
2. On the Assignments menu, click **Settings**. The **Settings** dialog box appears.
3. In the Category list, select **Device**. The **Device** page appears.
4. Click **Device and Pin Options**. The **Device and Pin Options** dialog box appears as shown in Figure 9–2.
5. In the **Device and Pin Options** dialog box, click the **Error Detection CRC** tab.
6. Turn on **Enable error detection CRC**.
7. In the **Divide error check frequency by** box, enter a valid divisor as documented in Table 9–5 on page 9–5.

In some applications, it is necessary for a device to wake up very quickly to begin operation. Cyclone IV devices offer the Fast-On feature to support fast wake-up time applications. The MSEL pin settings determine the POR time (t_{POR}) of the device.

For more information about the MSEL pin settings, refer to the *Configuration and Remote System Upgrades in Cyclone IV Devices* chapter.

For more information about the POR specifications, refer to the *Cyclone IV Device Datasheet* chapter.

Document Revision History

Table 11–3 lists the revision history for this chapter.

Table 11–3. Document Revision History

Date	Version	Changes
May 2013	1.3	Updated Note (4) in Table 11–1.
July 2010	1.2	■ Updated for the Quartus II software version 10.0 release. ■ Updated "I/O Pins Remain Tri-stated During Power-Up" section. ■ Updated Table 11–1.
February 2010	1.1	Updated Table 11–1 and Table 11–2 for the Quartus II software version 9.1 SP1 release.
November 2009	1.0	Initial release.

1. Cyclone IV Transceivers Architecture

CYIV-52001-3.7

Cyclone® IV GX devices include up to eight full-duplex transceivers at serial data rates between 600 Mbps and 3.125 Gbps in a low-cost FPGA. Table 1–1 lists the supported Cyclone IV GX transceiver channel serial protocols.

Table 1–1. Serial Protocols Supported by the Cyclone IV GX Transceiver Channels

Protocol	Data Rate (Gbps)	F324 and smaller packages	F484 and larger packages
PCI Express® (PCIe®) (1)	2.5	✓	✓
Gbps Ethernet (GbE)	1.25	✓	✓
Common Public Radio Interface (CPRI)	0.6144, 1.2288, 2.4576, and 3.072	✓ (2)	✓
OBSAI	0.768, 1.536, and 3.072	✓ (2)	✓
XAUI	3.125	—	✓
Serial digital interface (SDI)	HD-SDI at 1.485 and 1.4835	✓	✓
	3G-SDI at 2.97 and 2.967	—	
Serial RapidIO® (SRIO)	1.25, 2.5, and 3.125	—	✓
Serial Advanced Technology Attachment (SATA)	1.5 and 3.0	—	✓
V-by-one	3.125	—	✓
Display Port	1.62 and 2.7	—	✓

Notes to Table 1–1:

(1) Provides the physical interface for PCI Express (PIPE)-compliant interface that supports Gen1 ×1, ×2, and ×4 initial lane width configurations. When implementing ×1 or ×2 interface, remaining channels in the transceiver block are available to implement other protocols.

(2) Supports data rates up to 2.5 Gbps only.

You can implement these protocols through the ALTGX MegaWizard™ Plug-In Manager, which also offers the highly flexible Basic functional mode to implement proprietary serial protocols at the following serial data rates:

- 600 Mbps to 2.5 Gbps for devices in F324 and smaller packages
- 600 Mbps to 3.125 Gbps for devices in F484 and larger packages

For descriptions of the ports available when instantiating a transceiver using the ALTGX megafunction, refer to "Transceiver Top-Level Port Lists" on page 1–85.

For more information about Cyclone IV transceivers that run at ≥2.97 Gbps data rate, refer to the *Cyclone IV Device Family Pin Connection Guidelines*.

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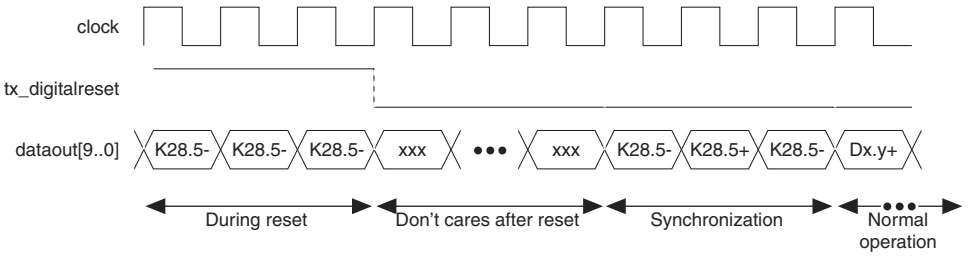
The following describes the 8B/10B encoder behavior in reset condition (as shown in Figure 1–7):

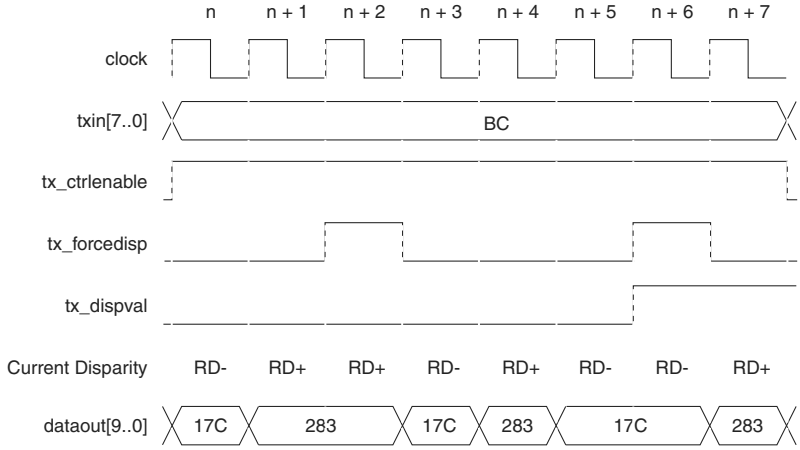
- During reset, the 8B/10B encoder ignores the inputs (`tx_datain` and `tx_ctrlenable` ports) from the FPGA fabric and outputs the K28.5 pattern from the RD- column continuously until the `tx_digitalreset` port is deasserted.
- Upon deassertion of the `tx_digitalreset` port, the 8B/10B encoder starts with a negative disparity and transmits three K28.5 code groups for synchronization before it starts encoding and transmitting data on its output.
- Due to some pipelining of the transmitter PCS, some "don't cares" (10'hxxx) are sent before the three synchronizing K28.5 code groups.

Figure 1–7. 8B/10B Encoder Behavior in Reset Condition



The encoder supports forcing the running disparity to either positive or negative disparity with `tx_forcedisp` and `tx_dispval` ports. Figure 1–8 shows an example of `tx_forcedisp` and `tx_dispval` port use, where data is shown in hexadecimal radix.

Figure 1–8. Force Running Disparity Operation



In this example, a series of K28.5 code groups are continuously sent. The stream alternates between a positive disparity K28.5 (RD+) and a negative disparity K28.5 (RD-) to maintain a neutral overall disparity. The current running disparity at time $n + 1$ indicates that the K28.5 in time $n + 2$ should be encoded with a negative disparity. Because `tx_forcedisp` is high at time $n + 2$, and `tx_dispval` is low, the K28.5

- transmitter in electrical idle
- receiver signal detect
- receiver spread spectrum clocking

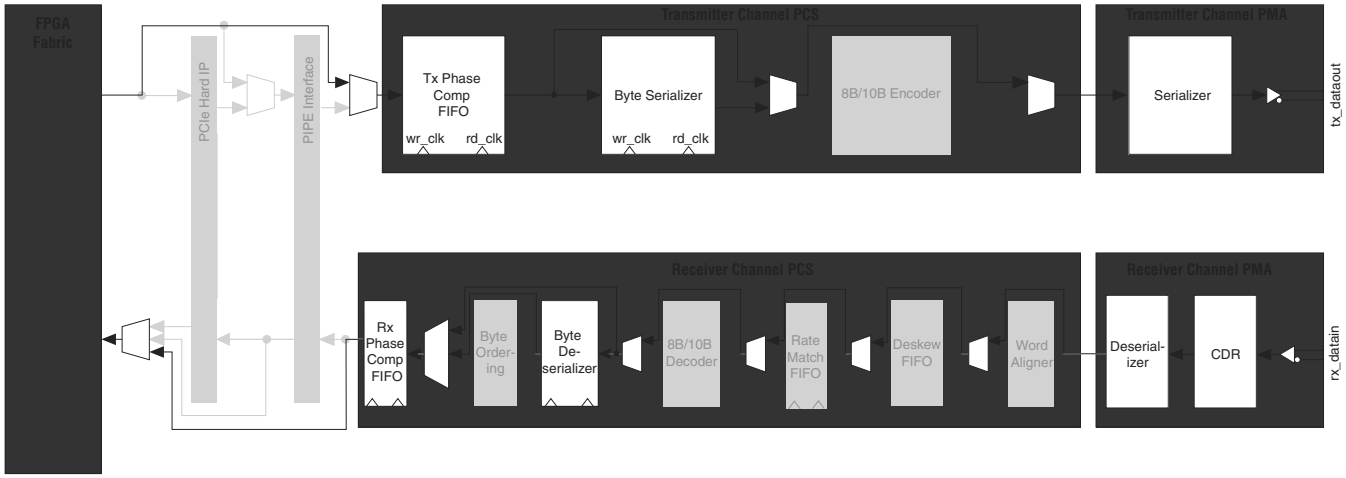
Low-Latency PCS Operation

When configured in low-latency PCS operation, the following blocks in the transceiver PCS are bypassed, resulting in a lower latency PCS datapath:

- 8B/10B encoder and decoder
- word aligner
- rate match FIFO
- byte ordering

Figure 1–47 shows the transceiver channel datapath in Basic mode with low-latency PCS operation.

Figure 1–47. Transceiver Channel Datapath in Basic Mode with Low-Latency PCS Operation



Transmitter in Electrical Idle

The transmitter buffer supports electrical idle state, where when enabled, the differential output buffer driver is tri-stated. During electrical idle, the output buffer assumes the common mode output voltage levels. For details about the electrical idle features, refer to "PCI Express (PIPE) Mode" on page 1–52.

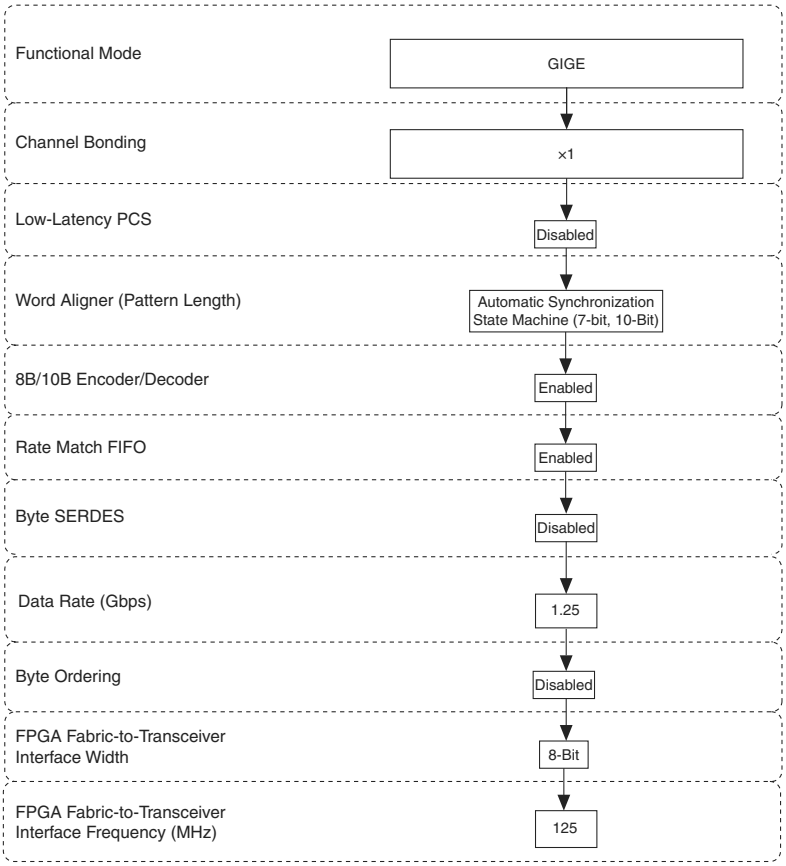
The transmitter in electrical idle feature is required for compliance to the version 2.00 of PHY Interface for the PCI Express (PIPE) Architecture specification for PCIe protocol implementation.

Signal Detect at Receiver

Signal detect at receiver is only supported when 8B/10B encoder/decoder block is enabled.

Figure 1–56 shows the transceiver configuration in GIGE mode.

Figure 1–56. Transceiver Configuration in GIGE Mode



When configured in GIGE mode, three encoded comma (/K28.5/) code groups are transmitted automatically after deassertion of `tx_digitalreset` and before transmitting user data on the `tx_datain` port. This could affect the synchronization state machine behavior at the receiver.

Depending on when you start transmitting the synchronization sequence, there could be an even or odd number of encoded data (/Dx.y/) code groups transmitted between the last of the three automatically sent /K28.5/ code groups and the first /K28.5/ code group of the synchronization sequence. If there is an even number of /Dx.y/ code groups received between these two /K28.5/ code groups, the first /K28.5/ code group of the synchronization sequence begins at an odd code group boundary. An IEEE802.3-compliant GIGE synchronization state machine treats this as an error condition and goes into the Loss-of-Sync state.

Clock Frequency Compensation

In GIGE mode, the rate match FIFO compensates up to ±100 ppm (200 ppm total) difference between the upstream transmitter and the local receiver reference clock. The GIGE protocol requires the transmitter to send idle ordered sets /I1/ (/K28.5/D5.6/) and /I2/ (/K28.5/D16.2/) during inter-packet gaps, adhering to the rules listed in the IEEE 802.3 specification.

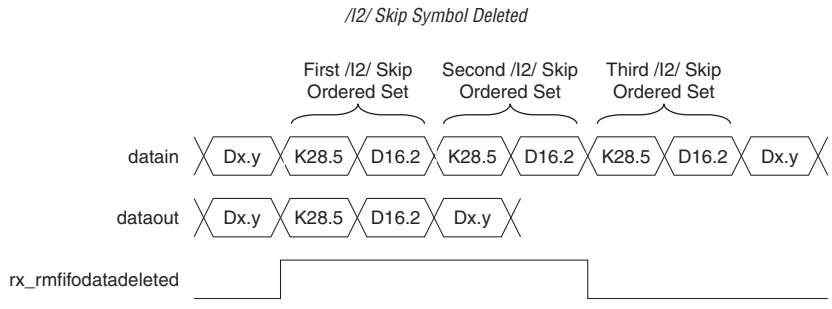
The rate match operation begins after the synchronization state machine in the word aligner indicates synchronization has been acquired by driving the `rx_syncstatus` signal high. The rate match FIFO deletes or inserts both symbols of the /I2/ ordered sets (/K28.5/ and /D16.2/) to prevent the rate match FIFO from overflowing or underflowing. It can insert or delete as many /I2/ ordered sets as necessary to perform the rate match operation.

If you have the auto-negotiation state machine in the FPGA, note that the rate match FIFO is capable of inserting or deleting the first two bytes (/K28.5//D2.2/) of /C2/ ordered sets during auto-negotiation. However, the insertion or deletion of the first two bytes of /C2/ ordered sets can cause the auto-negotiation link to fail. For more information, refer to the Altera Knowledge Base Support Solution.

The status flags `rx_rmfifodatadeleted` and `rx_rmfifodatainserted` to indicate rate match FIFO deletion and insertion events, respectively, are forwarded to the FPGA fabric. These two flags are asserted for two clock cycles for each deleted and inserted /I2/ ordered set.

Figure 1–58 shows an example of rate match FIFO deletion where three symbols must be deleted. Because the rate match FIFO can only delete /I2/ ordered sets, it deletes two /I2/ ordered sets (four symbols deleted).

Figure 1–58. Example of Rate Match FIFO Deletion in GIGE Mode



Document Revision History

Table 1–30 lists the revision history for this chapter.

Table 1–30. Document Revision History

Date	Version	Changes
February 2015	3.7	■ Updated the GiGE row in Table 1–14. ■ Updated the "GIGE Mode" section. ■ Updated the note in the "Clock Frequency Compensation" section.
October 2013	3.6	Updated Figure 1–15 and Table 1–4.
May 2013	3.5	Updated Table 1–27 by setting "rx_locktodata" and "rx_locktorefclk" to "Input"
October 2012	3.4	■ Updated the data rate for the V-by-one protocol and the F324 package support in HD-SDI in Table 1–1. ■ Updated note (1) to Figure 1–27. ■ Added latency information to Figure 1–67.
November 2011	3.3	■ Updated "Word Aligner" and "Basic Mode" sections. ■ Updated Figure 1–37.
December 2010	3.2	■ Updated for the Quartus II software version 10.1 release. ■ Updated Table 1–1, Table 1–5, Table 1–11, Table 1–14, Table 1–24, Table 1–25, Table 1–26, Table 1–27, Table 1–28, and Table 1–29. ■ Updated "8B/10B Encoder", "Transmitter Output Buffer", "Receiver Input Buffer", "Clock Data Recovery", "Miscellaneous Transmitter PCS Features", "Miscellaneous Receiver PCS Feature", "Input Reference Clocking", "PCI Express (PIPE) Mode", "Channel Deskewing", "Lane Synchronization", "Serial Loopback", and "Self Test Modes" sections. ■ Added Figure 1–9, Figure 1–10, Figure 1–19, Figure 1–20, and Figure 1–43. ■ Updated Figure 1–53, Figure 1–55, Figure 1–59, Figure 1–60, Figure 1–69, Figure 1–70, Figure 1–71, Figure 1–72, Figure 1–73, and Figure 1–74.
November 2010	3.1	Updated Introductory information.
July 2010	3.0	■ Updated information for the Quartus II software version 10.0 release. ■ Reset control, power down, and dynamic reconfiguration information moved to new *Cyclone IV Reset Control and Power Down* and *Cyclone IV Dynamic Reconfiguration* chapters.

Dynamic Reconfiguration Controller Port List

Table 3–2 lists the input control ports and output status ports of the dynamic reconfiguration controller.

Table 3–2. Dynamic Reconfiguration Controller Port List (ALTGX_RECONFIG Instance) (Part 1 of 7)

Port Name	Input/ Output	Description
Clock Inputs to ALTGX_RECONFIG Instance		
reconfig_clk	Input	The frequency range of this clock depends on the following transceiver channel configuration modes: ■ **Receiver only** (37.5 MHz to 50 MHz) ■ **Receiver and Transmitter** (37.5 MHz to 50 MHz) ■ **Transmitter only** (2.5 MHz to 50 MHz) By default, the Quartus® II software assigns a global clock resource to this port. This clock must be a free-running clock sourced from an I/O clock pin. Do not use dedicated transceiver REFCLK pins or any clocks generated by transceivers.
ALTGX and ALTGX_RECONFIG Interface Signals		
reconfig_fromgxb [n..0]	Input	An output port in the ALTGX instance and an input port in the ALTGX_RECONFIG instance. This signal is transceiver-block based. Therefore, the width of this signal increases in steps of 5 bits per transceiver block. In the ALTGX MegaWizard Plug-In Manager, the width of this signal depends on the number of channels you select in the **What is the number of channels?** option in the **General** screen. For example, if you select the number of channels in the ALTGX instance as follows: 1 ≤ Channels ≤ 4, then the output port reconfig_fromgxb[4..0] = 5 bits 5 ≤ Channels ≤ 8, then the output port reconfig_fromgxb[9..0] = 10 bits 9 ≤ Channels ≤ 12, then the output port reconfig_fromgxb[14..0] = 15 bits 13 ≤ Channels ≤ 16, then the output port reconfig_fromgx[19..0] = 20 bits To connect the reconfig_fromgxb port between the ALTGX_RECONFIG instance and multiple ALTGX instances, follow these rules: ■ Connect the reconfig_fromgxb[4..0] of ALTGX Instance 1 to the reconfig_fromgxb[4..0] of the ALTGX_RECONFIG instance. Connect the reconfig_fromgxb[] port of the next ALTGX instance to the next available bits of the ALTGX_RECONFIG instance, and so on. ■ Connect the reconfig_fromgxb port of the ALTGX instance, which has the highest **What is the starting channel number?** option, to the MSB of the reconfig_fromgxb port of the ALTGX_RECONFIG instance. The Quartus II Fitter produces a warning if the dynamic reconfiguration option is enabled in the ALTGX instance but the reconfig_fromgxb and reconfig_togxb ports are not connected to the ALTGX_RECONFIG instance.
reconfig_togxb [3..0]	Output	An input port of the ALTGX instance and an output port of the ALTGX_RECONFIG instance. You must connect the reconfig_togxb[3..0] input port of every ALTGX instance controlled by the dynamic reconfiguration controller to the reconfig_togxb[3..0] output port of the ALTGX_RECONFIG instance. The width of this port is always fixed to 4 bits.

PMA Control Ports Used in a Read Transaction

- `tx_vodctrl_out` is 3 bits per channel
- `tx_preemp_out` is 5 bits per channel
- `rx_eqdcgain_out` is 2 bits per channel
- `rx_eqctrl_out` is 4 bits per channel

For example, assume the number of channels controlled by the dynamic reconfiguration controller is two, `tx_vodctrl_out` is 6 bits wide.

Write Transaction

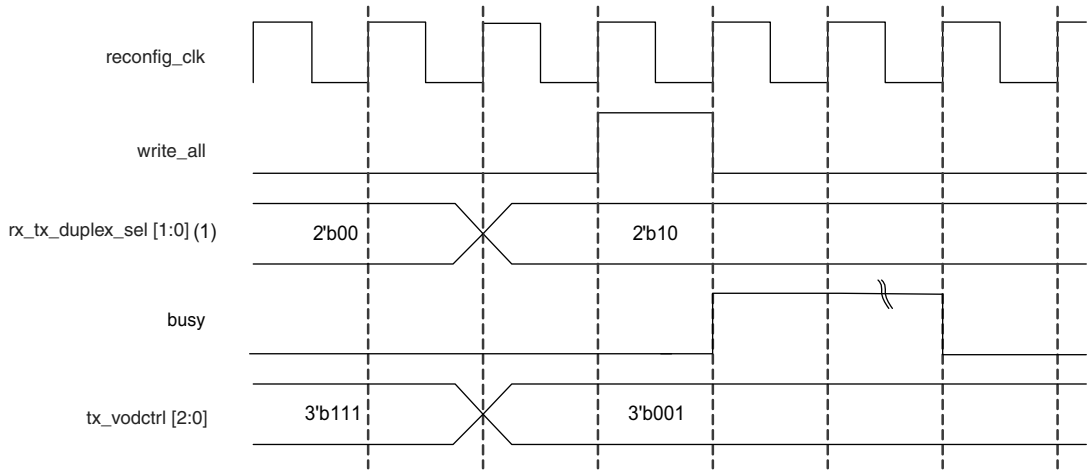
The value you set at the selected PMA control ports is written to all the transceiver channels connected to the ALTGX_RECONFIG instance.

For example, assume you have enabled `tx_vodctrl` in the ALTGX_RECONFIG MegaWizard Plug-In Manager to reconfigure the V_{OD} of the transceiver channels. To complete a write transaction to reconfigure the V_{OD}, perform the following steps:

1. Before you initiate a write transaction, set the selected PMA control ports to the desired settings (for example, `tx_vodctrl` = **3'b001**).
2. Set the `rx_tx_duplex_sel` port to **2'b10** so that only the transmit PMA controls are written to the transceiver channel.
3. Ensure that the `busy` signal is low before you start a write transaction.
4. Assert the `write_all` signal for one `reconfig_clk` clock cycle. This initiates the write transaction.
5. The `busy` output status signal is asserted high to indicate that the dynamic reconfiguration controller is busy writing the PMA control values. When the write transaction has completed, the `busy` signal goes low.

Figure 3–6 shows the write transaction for Method 2.

Figure 3–6. Write Transaction Waveform—Use the same control signal for all the channels Option



Note to Figure 3–6:

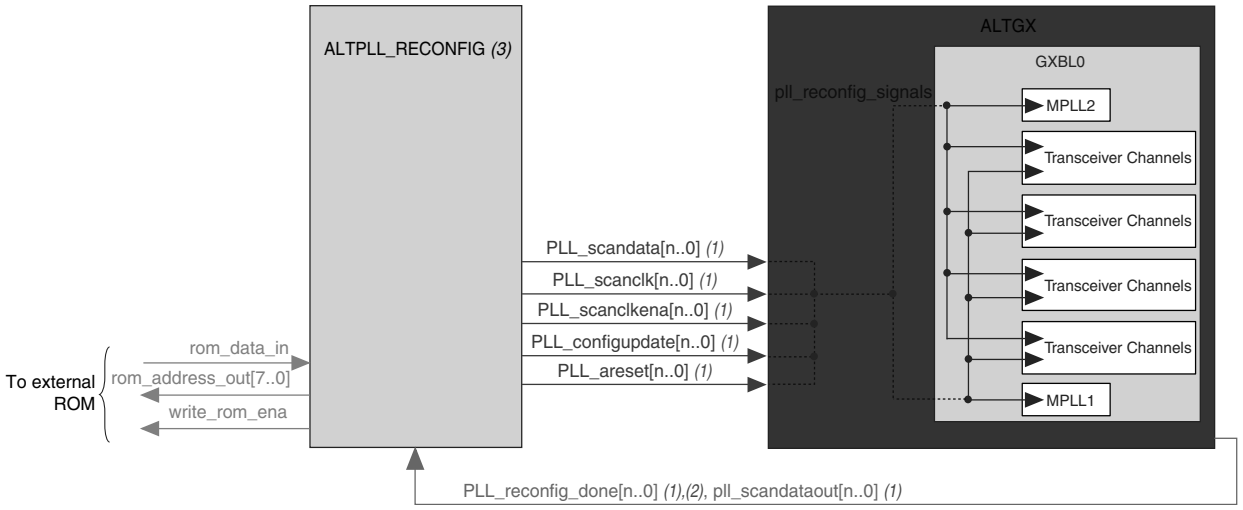
(1) In this waveform example, you want to write to only the transmitter portion of the channel.

The .**mif** files carries the reconfiguration information that will be used to reconfigure the multipurpose PLL or general purpose PLL dynamically. The .**mif** contents is generated automatically when you select the **Enable PLL Reconfiguration** option in the **Reconfiguration Setting** in ALTGX instances. The **.mif** files will be generated based on the data rate and input reference clock setting in the ALTGX MegaWizard. You must use the external ROM and feed its content to the ALTPLL_RECONFIG megafunction to reconfigure the multipurpose PLL setting.

For more information about instantiating the ALTPLL_Reconfig, refer to the *AN 609: Implementing Dynamic Reconfiguration in Cyclone IV GX Devices*.

Figure 3–16 shows the connection for PLL reconfiguration mode.

Figure 3–16. ALTGX and ALTPLL_RECONFIG Connection for PLL Reconfiguration Mode



Notes to Figure 3–16:

(1) *<n>* = (number of transceiver PLLs configured in the ALTGX MegaWizard) - 1.

(2) You must connect the `pll_reconfig_done` signal from the ALTGX to the `pll_scandone` port from ALTPLL_RECONFIG.

(3) You need two ALTPLL_RECONFIG controllers if you have two separate ALTGX instances with transceiver PLL instantiated in each ALTGX instance.

For more information about connecting the ALTPLL_RECONFIG and ALTGX instances, refer to the *AN 609: Implementing Dynamic Reconfiguration in Cyclone IV GX Devices*.

Functional Simulation of the Dynamic Reconfiguration Process

This section describes the points to be considered during functional simulation of the dynamic reconfiguration process.

- You must connect the ALTGX_RECONFIG instance to the ALTGX_instance/ALTGX instances in your design for functional simulation.
- The functional simulation uses a reduced timing model of the dynamic reconfiguration controller. The duration of the offset cancellation process is 16 `reconfig_clk` clock cycles for functional simulation only.
- The `gxb_powerdown` signal must not be asserted during the offset cancellation sequence (for functional simulation and silicon).

Document Revision History

Table 3–8 lists the revision history for this chapter.

Table 3–8. Document Revision History

Date	Version	Changes
November 2011	2.1	■ Updated "Dynamic Reconfiguration Controller Architecture", "PMA Controls Reconfiguration Mode", "PLL Reconfiguration Mode", and "Error Indication During Dynamic Reconfiguration" sections. ■ Updated Table 3–2 and Table 3–4.
December 2010	2.0	■ Updated for the Quartus II software version 10.1 release. ■ Updated Table 3–1, Table 3–2, Table 3–3, Table 3–4, Table 3–5, and Table 3–6. ■ Added Table 3–7. ■ Updated Figure 3–1, Figure 3–11, Figure 3–13, and Figure 3–14. ■ Updated "Offset Cancellation Feature", "Error Indication During Dynamic Reconfiguration", "Data Rate Reconfiguration Mode Using RX Local Divider", "PMA Controls Reconfiguration Mode", and "Control and Status Signals for Channel Reconfiguration" sections.
July 2010	1.0	Initial release.

Table 1–35. Emulated LVDS Transmitter Timing Specifications for Cyclone IV Devices (1), (3) (Part 2 of 2)

Symbol	Modes	C6		C7, I7		C8, A7		C8L, I8L		C9L		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t_{DUTY}	—	45	55	45	55	45	55	45	55	45	55	%
TCCS	—	—	200	—	200	—	200	—	200	—	200	ps
Output jitter (peak to peak)	—	—	500	—	500	—	550	—	600	—	700	ps
t_{LOCK} (2)	—	—	1	—	1	—	1	—	1	—	1	ms

Notes to Table 1–35:

(1) Cyclone IV E—emulated LVDS transmitter is supported at the output pin of all I/O Banks.
Cyclone IV GX—emulated LVDS transmitter is supported at the output pin of I/O Banks 3, 4, 5, 6, 7, 8, and 9.

(2) t_{LOCK} is the time required for the PLL to lock from the end-of-device configuration.

(3) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades. Cyclone IV GX devices only support C6, C7, C8, and I7 speed grades.

Table 1–36. LVDS Receiver Timing Specifications for Cyclone IV Devices (1), (3)

Symbol	Modes	C6		C7, I7		C8, A7		C8L, I8L		C9L		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
f_{HSCLK} (input clock frequency)	×10	10	437.5	10	370	10	320	10	320	10	250	MHz
	×8	10	437.5	10	370	10	320	10	320	10	250	MHz
	×7	10	437.5	10	370	10	320	10	320	10	250	MHz
	×4	10	437.5	10	370	10	320	10	320	10	250	MHz
	×2	10	437.5	10	370	10	320	10	320	10	250	MHz
	×1	10	437.5	10	402.5	10	402.5	10	362	10	265	MHz
HSIODR	×10	100	875	100	740	100	640	100	640	100	500	Mbps
	×8	80	875	80	740	80	640	80	640	80	500	Mbps
	×7	70	875	70	740	70	640	70	640	70	500	Mbps
	×4	40	875	40	740	40	640	40	640	40	500	Mbps
	×2	20	875	20	740	20	640	20	640	20	500	Mbps
	×1	10	437.5	10	402.5	10	402.5	10	362	10	265	Mbps
SW	—	—	400	—	400	—	400	—	550	—	640	ps
Input jitter tolerance	—	—	500	—	500	—	550	—	600	—	700	ps
t_{LOCK} (2)	—	—	1	—	1	—	1	—	1	—	1	ms

Notes to Table 1–36:

(1) Cyclone IV E—LVDS receiver is supported at all I/O Banks.
Cyclone IV GX—LVDS receiver is supported at I/O Banks 3, 4, 5, 6, 7, 8, and 9.

(2) t_{LOCK} is the time required for the PLL to lock from the end-of-device configuration.

(3) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades. Cyclone IV GX devices only support C6, C7, C8, and I7 speed grades.

External Memory Interface Specifications

The external memory interfaces for Cyclone IV devices are auto-calibrating and easy to implement.